UNITED STATES SECURITIES AND EXCHANGE COMMISSION

Washington, D.C. 20549

FORM 8-K

CURRENT REPORT Pursuant to Section 13 OR 15(d) of The Securities Exchange Act of 1934

Date of Report (Date of earliest event reported): November 13, 2018

Atomera Incorporated

(Exact name of registrant as specified in its charter)

Delaware

(State or Other Jurisdiction of Incorporation)

001-37850

(Commission File Number) 30-0509586

(I.R.S. Employer Identification Number)

750 University Avenue, Suite 280 Los Gatos, California 95032

(Address of principal executive offices) (zip code)

(408) 442-5248

(Registrant's telephone number, including area code)

(Former name or former address, if changed since last report)

Check the appropriate box below if the Form 8-K filing is intended to simultaneously satisfy the filing obligation of the registrant under any of the following provisions (see General Instruction A.2. below):

- □ Written communications pursuant to Rule 425 under the Securities Act (17 CFR 230.425)
- □ Soliciting material pursuant to Rule 14a-12 under the Exchange Act (17 CFR 240.14a-12)
- □ Pre-commencement communications pursuant to Rule 14d-2(b) under the Exchange Act (17 CFR 240.14d-2(b))
- Pre-commencement communications pursuant to Rule 13e-4(c) under the Exchange Act (17 CFR 240.13e-4(c))

Indicate by check mark whether the registrant is an emerging growth company as defined in Rule 405 of the Securities Act of 1933 (§230.405 of this chapter) or Rule 12b-2 of the Securities Exchange Act of 1934 (§240.12b-2 of this chapter).

Emerging growth company ⊠

If an emerging growth company, indicate by check mark if the registrant has elected not to use the extended transition period for complying with any new or revised financial accounting standards provided pursuant to Section 13(a) of the Exchange Act.

Item 8.01 Other Events.

On November 13, 2018, Atomera Incorporated distributed an investor presentation on its website, www.atomera.com. The investor presentation is attached hereto as Exhibit 99.1.

The information in this Current Report, including the exhibit attached hereto, is furnished pursuant to Item 8.01 and shall not be deemed "filed" for any purpose, including for the purposes of Section 18 of the Securities Exchange Act of 1934, as amended (the "Exchange Act"), or otherwise subject to the liabilities of that Section. The information in this Current Report on Form 8-K shall not be deemed incorporated by reference into any filing under the Securities Act of 1933, as amended (the "Securities Act"), or the Exchange Act regardless of any general incorporation language in such filing.

Item 9.01 Financial Statements and Exhibits.

(d) Exhibits:

99.1 Investor presentation November 13, 2018 Atomera Incorporated

SIGNATURES

Pursuant to the requirements of the Securities Exchange Act of 1934, the Registrant has duly caused this report to be signed on its behalf by the undersigned, hereunto duly authorized.

ATOMERA INCORPORATED

By: /s/ Francis Laurencio

Francis Laurencio Chief Financial Officer

Date: November 13, 2018



Safe Harbor



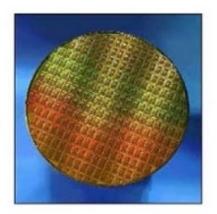
This presentation contains forward-looking statements concerning Atomera Incorporated (""Atomera," the "Company," "we," "us," and "our"). The words "believe," "may," "will," "potentially," "estimate," "continue," "anticipate," "intend," "could," "would," "project," "plan," "expect" and similar expressions that convey uncertainty of future events or outcomes are intended to identify forward-looking statements. These forward-looking statements are subject to a number of risks, uncertainties and assumptions, including those described in the "Risk Factors" section of our Prospectus Supplement filed pursuant to Rule 424(b)(5) with the SEC on October 11, 2018 (the "Prospectus Supplement"). In light of these risks, uncertainties and assumptions, the forward-looking events and circumstances discussed in this presentation may not occur and actual results could differ materially and adversely from those anticipated or implied in our forward-looking statements. You should not rely upon forward-looking statements as predictions of future events. Although we believe that the expectations reflected in our forward-looking statements are reasonable, we cannot guarantee that the future results, levels of activity, performance or events and circumstances described in the forward-looking statements will be achieved or occur.

This presentation contains only basic information concerning Atomera. The Company's filings with the Securities Exchange Commission, including the Prospectus Supplement, include more information about factors that could affect the Company's operating and financial results. We assume no obligation to update information contained in this presentation. Although this presentation may remain available on the Company's website or elsewhere, its continued availability does not indicate that we are reaffirming or confirming any of the information contained herein.

Investment Overview



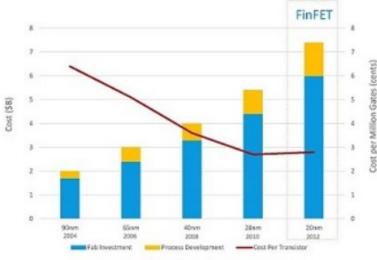
- Mears Silicon Technology (MST®) is a thin film used to enhance semiconductors
 - · Results in higher performance, lower power, and lower costs for ICs
- · Capital-light IP licensing business
 - · Robust and growing patent portfolio
- Engaged with 50% of world's top semiconductor makers
- Licenses with Asahi Kasei Microdevices (AKM) and STMicroelectronics
- Strong team to commercialize technology
 - · CEO ran \$1B+ divisions at Broadcom and Altera
 - · Founder/CTO co-invented the EDFA for long-haul optical applications
 - Deeply experienced materials science and semiconductor engineering team
- · Well funded after with over \$20M of cash



Extending Moore's Law at every node



The skyrocketing cost of new nodes



Source: McKinsey & Co, "On Semiconductors"

MST: A cost effective solution to semiconductor's biggest problem

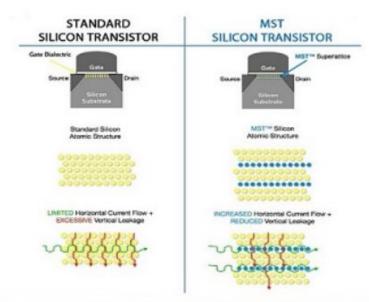
- · MST can deliver a half to a full node of improvements
 - · Performance strengthened at any process node
 - · Continues driving down the cost per transistor
 - · Also solves problems in FinFET transistors
- . MST cost is tiny in comparison to developing a new node
 - IDM Process development/licensing is ~\$10M
 - Foundry equipment upgrades cost is ~\$30-50M
 - · A foundry for a new node costs billions

"From an economic standpoint, Moore's law is over."

Silicon Valley analyst Linley Gwynnap, quoted in "After Moore's Law," The Economist, 12 March 2016

MST Technology





Potential Benefits

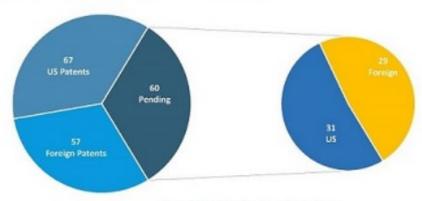
- Improved Efficiency
 - · Higher transistor performance
 - Lower power consumption
 - · Better reliability
- Lower cost
 - · Reduced die size
 - · Improved yield
 - · Higher throughput
- · Same benefits as a node shrink

Patent Portfolio



Comprehensive

184 Patents Granted and Pending



Core MST Method and Device MST Enabled Devices/Architecture Next-Gen Architectures using MST

Discoverable



These distinctive layers are visible on products using MST

Extensive know-how

Extends life and value of patents

Semiconductor Ecosystem



Integrated Device Manufacturers -Foundry Micron (intel) TOSHIBA SAMSUNG HHirace DB HiTek TOWERJOL MagnaChip TEXAS INSTRUMENTS **(infineon** NO FUĴÎTSU RENESAS @ BROADCOM QUALCOM MICTON QOCVO **Tool Suppliers** APPLIED. **KOKUSAI** SYNOPSYS.

Market Segment Strategy



Leading Analog	Mainstream	Leading Planar	3D
Analog, PMIC, RF	IoT, RF, Automotive	DRAM; Digital Processors	FinFET, Nanowire
Key Players: TSMC, TI, NXP, ST Micro	Key Players: TSMC, UMC, SMiC, Global Foundries	Key Players: TSMC, GF, Samsung, Hynix, Micron	Key Players: Intel, TSMC, Samsung, GF
Atomera solutions MST can lower die cost while improving other parameters	Atomera solutions MST allows fab life extension by upping performance within node	Atomera solutions MST provides a low cost alternative to extend planar life	Atomera solutions MST is a low risk, silicon based technology with multiple benefits
180nm 130nm	90nm 65nm 40nm	28nm 16nm 14nm	10nm 7nm 5nm

Engaged with customers in all four segments

Significant TAM



- \$7.0 billion total addressable market
 - at 2% royalty per wafer selling price²
- Top 20 wafer capacity leaders represent 84% of total industry capacity

-	Dancacante	spendage may	roome (3)	Omm eaul.

Nepresens were per year (commend).
 2. 2016 Industry wafer ASP: \$1,637; target royalty 1-3%
 Source: IC Insights Global Wafer Capacity 2017-2021 report

Company	Type	Segment	Capacity ¹	% of Total
Samsung Semiconductor	IDM	Memory	31,185,000	14.6%
TSMC	Foundry	Logic	24,147,804	11.3%
Micron Technology	IDM	Memory	18,486,000	8.7%
SK Hynix	Foundry	Memory	18,350,000	8.6%
Toshiba Semiconductor	IDM	Memory	13,905,000	6.5%
GlobalFoundries	Foundry	Logic	9,720,000	4.6%
Intel	IDM	MCU	8,181,000	3.8%
Texas Instruments (TI)	IDM	Analog	7,450,548	3.5%
UMC (United Microelectronics)	Foundry	Logic	7,378,356	3.5%
STMicroelectronics	IDM	Analog	5,532,072	2.6%
SMIC	Foundry	Logic	5,193,000	2.4%
Infineon Technologies	IDM	Analog	4,509,708	2.1%
ON Semiconductor	IDM	Analog	4,493,904	2.1%
Powerchip Technology	Foundry	Logic	3,756,000	1.8%
TowerJazz	Foundry	Analog	3,572,820	1.7%
NXP Semiconductors	IDM	Analog	3,000,000	1.4%
Renesas Electronics	IDM	Other	2,833,488	1.3%
Japan Semiconductor Corp. (Toshiba)	Foundry	Analog	2,759,328	1.3%
Huahong Grace Semiconductor (HHGrace)	Foundry	Analog	2,556,000	1.2%
IM Flash	IDM	Memory	2,160,000	1.0%
Top 20 Total			179,180,028	83.9%
Other			34,419,972	16.1%
Total Industry			213,600,000	100.0%

ST Micro & AKM Commercial Licenses



- Atomera Licenses MST to Asahi Kasei Microdevices (AKM) Sept 25, 2018
 - Japanese manufacturer of high end ICs for consumer, automotive and industrial
 - Division of Asahi Kasei Chemical Group
 - · Long time partner of Atomera
 - First commercial licensee of Atomera's MST technology
 - Integration License



- Atomera Licenses MST to STMicroelectronics October 2, 2018
 - One of the world's largest semiconductor companies
 - · 2017 revenue: \$8.3B
 - Leading IDM making solutions for Smart Driving, Internet of Things
 - · Working with MST for less than two years
 - Integration License



Customer Engagement & Revenue Model



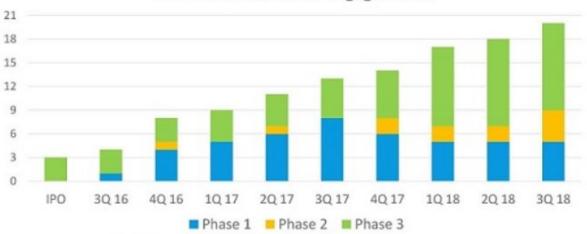
		Customer Wafer Manufacturing					
		Atomera MST [®] Deposition			Customer MST ⁶ Deposition		
Phase	1. Planning	2. Setup	3. Integration	4. Installation	5. Qualification	6. Production	
Revenue Type			Engineering Services	Integration License	Manufacturing License	Distribution License	Royalties

-11

Growing Customer Pipeline



Number of Customer Engagements



- 16 customers, 20 engagements
- · Working with 50% of the world's top semiconductor makers*

Financial Overview and Capitalization



Non-GAAP P&L®						
	Q3 2018	Q2 2018	Q1 2018			
Revenue	-	96	-			
Cost of goods sold	-	113				
Gross profit	_	(17)				
Operating expenses						
Research and development	1,773	1,590	1,578			
General and administrative	867	803	796			
Selling and marketing	205	182	212			
Total operating expenses	2,845	2,575	2,586			
Adjusted EBITDA (Non-GAAP)	(2,845)	(2,592)	(2,586)			

Summary Capitalization Table at 9/30/2018			Pro Forma for offering	
	Common Shares	WAEP	Common Shares	
Shares Outstanding	12,408,525		15,033,525	
Warrants	764,665	\$5.75	764,665	
Stock Options	1,359,562	\$7.02	1,359,562	
FD SO	14,532,752		17,157,752	

Balance Sheet							
(in thousands)	Q3 2018	Q2 2018	Q1 2018				
Current assets	-						
Cash and cash equivalents	9,957	12,254	14,547				
Accounts receivable	75	96	375				
Prepaids and other current assets	227	296	401				
Total current assets	10,259	12,646	14,948				
Property and equipment, net	63	65	68				
Deferred Offering Costs	73	9 <u>0</u>					
Security deposit	13	13	13				
Total assets	10,408	12,724	15,029				
Liabilities							
Accounts payable	354	339	283				
Accrued expenses	319	285	200				
Accrued payroll and related	703	338	226				
Total liabilities	1,451	962	71				
Shareholders' equity							
Common stock	12	12	12				
Additional paid-in capital	127,078	127,078	126,457				
Accumulated deficit	(118,763)	(115,328)	(112,157				
Total shareholders' equity	8,957	11,762	14,317				
Total liabilities and shareholders' equity	10,408	12,724	15,029				

^{*} Adjusted EBITDA is a non-GAAP financial measure. A full reconciliation of GAAP and non-GAAP results is contained on slide 15

Summary



- · Signed first two customer licenses with AKM and STMicroelectronics
- · High margin, recurring revenue financial model
- · Solid cash position
- · Strong technology and patent position
- · Ramping commercial license revenues



Financial Overview and Capitalization



	Q3 2018	Q2 2018	Q1 2018
Adjusted EBITDA (Non-GAAP)	(2,845)	(2,592)	(2,586)
Add (subtract) the following items			
Interest income	48	50	47
Depreciation and amortization	(8)	(8)	(8)
Stock-based compensation	(630)	(621)	(545)
Net loss (GAAP)	(3,435)	(3,171)	(3,092)

Adjusted EBITDA is determined by taking net loss and eliminating the impacts of interest, taxes, depreciation, amortization, stockbased compensation, the change in fair value of derivative liabilities, and the gain on the extinguishment of debt. Our definition of adjusted EBITDA may not be comparable to the definitions of similarly titled measures used by other companies. We believe that this non-GAAP financial measure, viewed in addition to and not in lieu of its reported GAAP results, provides useful information to investors by providing a more focused measure of operating results. Here are providing a reconciliation to our publicly reported GAAP income statement.